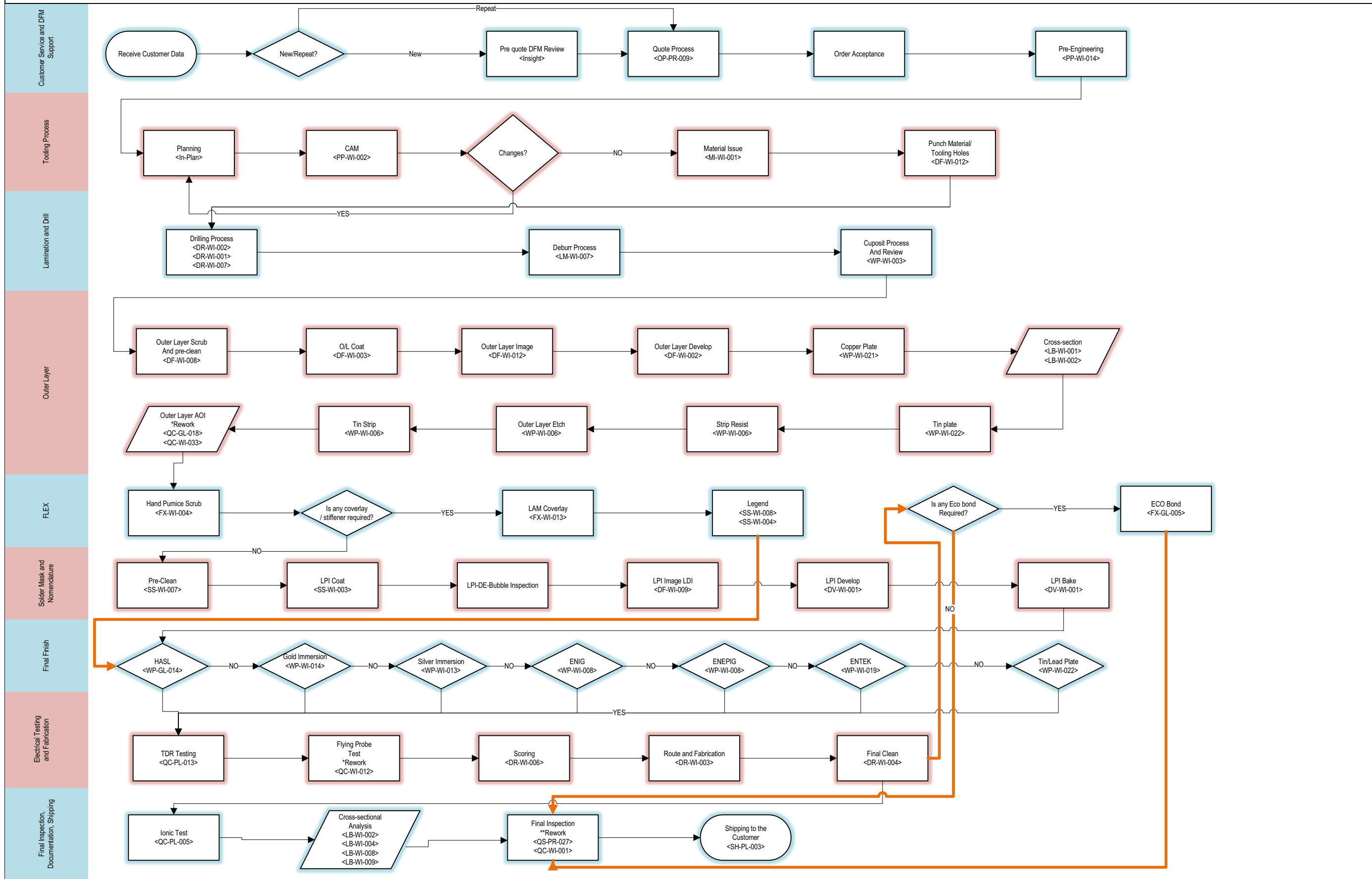


Flex (Type 1 & 2) Printed Circuit Board Process Flow Chart



NOTE: *Rework : Potential rework for the removal of residual plating materials or extraneous copper
 **Rework: Potential Rework touch-up for solder mask imperfections